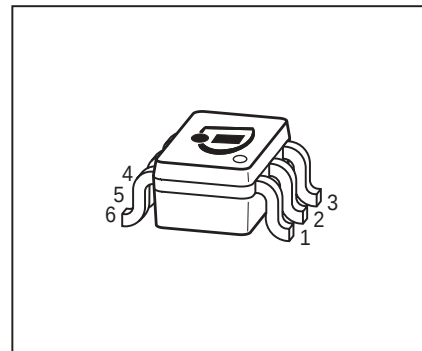
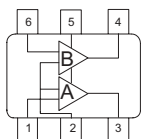


DUAL N-Channel MOSFET Tetrode

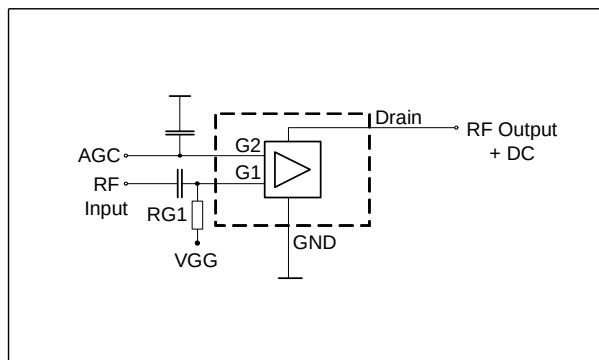
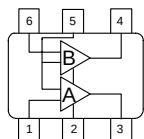
- Two gain controlled input stages for UHF and VHF -tuners e.g. (NTSC, PAL)
- Optimized for UHF (amp. B) and VHF (amp. A)
- Integrated gate protection diodes
- High AGC-range, low noise figure, high gain
- Improved cross modulation at gain reduction
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101



BG3123



BG3123R



ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Type	Package	Pin Configuration						Marking
BG3123	SOT363	1=G1*	2=G2	3=D*	4=D**	5=S	6=G1**	KOs
BG3123R	SOT363	1=G1*	2=S	3=D*	4=D**	5=G2	6=G1**	KRs

* For amp. A; ** for amp. B

180° rotated tape loading orientation available

Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	8	V
Continuous drain current	I_D	25	mA
amp. A		20	
amp. B			
Gate 1/ gate 2-source current	$\pm I_{G1/2SM}$	1	
Gate 1/ gate 2-source voltage	$\pm V_{G1/G2S}$	6	V
Total power dissipation	P_{tot}	200	mW
Storage temperature	T_{stg}	-55 ... 150	°C
Channel temperature	T_{ch}	150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Channel - soldering point ¹⁾	R_{thchs}	≤ 150	K/W

¹⁾For calculation of R_{thJA} please refer to Application Note Thermal Resistance

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

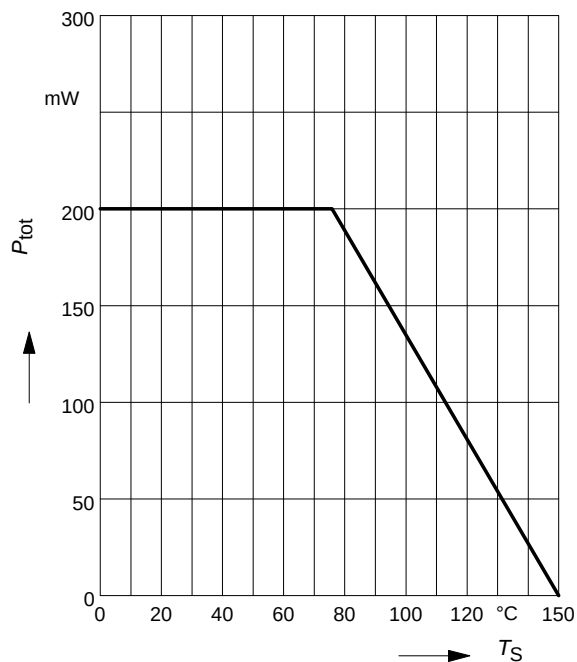
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Drain-source breakdown voltage $I_D = 10\ \mu\text{A}$, $V_{G1S} = 0\ \text{V}$, $V_{G2S} = 0\ \text{V}$	$V_{(\text{BR})\text{DS}}$	12	-	-	V
Gate1-source breakdown voltage $+I_{G1S} = 10\ \text{mA}$, $V_{G2S} = 0\ \text{V}$, $V_{\text{DS}} = 0\ \text{V}$	$+V_{(\text{BR})\text{G1SS}}$	6	-	15	
Gate2-source breakdown voltage $+I_{G2S} = 10\ \text{mA}$, $V_{G1S} = 0\ \text{V}$, $V_{\text{DS}} = 0\ \text{V}$	$+V_{(\text{BR})\text{G2SS}}$	6	-	15	
Gate1-source leakage current $V_{G1S} = 6\ \text{V}$, $V_{G2S} = 0\ \text{V}$	$+I_{\text{G1SS}}$	-	-	50	μA
Gate2-source leakage current $V_{G2S} = 8\ \text{V}$, $V_{G1S} = 0\ \text{V}$, $V_{\text{DS}} = 0\ \text{V}$	$+I_{\text{G2SS}}$	-	-	50	nA
Drain current $V_{\text{DS}} = 5\ \text{V}$, $V_{G1S} = 0\ \text{V}$, $V_{G2S} = 4.5\ \text{V}$	I_{DSS}	-	-	10	μA
Drain-source current $V_{\text{DS}} = 5\ \text{V}$, $V_{G2S} = 4\ \text{V}$, $R_{\text{G1}} = 60\ \text{k}\Omega$, amp. A $V_{\text{DS}} = 5\ \text{V}$, $V_{G2S} = 4\ \text{V}$, $R_{\text{G1}} = 50\ \text{k}\Omega$, amp. B	I_{DSX}	- -	14 14	- -	mA
Gate1-source pinch-off voltage $V_{\text{DS}} = 5\ \text{V}$, $V_{G2S} = 4\ \text{V}$, $I_D = 20\ \mu\text{A}$	$V_{\text{G1S(p)}}$	-	0.7	-	
Gate2-source pinch-off voltage $V_{\text{DS}} = 5\ \text{V}$, $I_D = 20\ \mu\text{A}$	$V_{\text{G2S(p)}}$	-	0.6	-	

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics $V_{DS} = 5V$, $V_{G2S} = 4V$, ($I_D = 14\text{ mA}$) (verified by random sampling)					
Forward transconductance amp. A amp. B	g_{fs}	- -	30 25	- -	mS
Gate1 input capacitance $f = 10\text{ MHz}$, amp. A $f = 10\text{ MHz}$, amp. B	C_{g1ss}	- -	1.9 1.5	- -	pF
Output capacitance $f = 10\text{ MHz}$, amp. A $f = 10\text{ MHz}$, amp. B	C_{dss}	- -	1.3 1.1	- -	
Power gain $f = 800\text{ MHz}$, amp. A $f = 800\text{ MHz}$, amp. B $f = 45\text{ MHz}$, amp. A $f = 45\text{ MHz}$, amp. B	G_p	- - - -	25 24 32 30	- - - -	
Noise figure $f = 800\text{ MHz}$, amp. A $f = 800\text{ MHz}$, amp. B $f = 45\text{ MHz}$, amp. A $f = 45\text{ MHz}$, amp. B	F	- - - -	1.8 1.8 1.4 1.6	- - - -	dB
Gain control range $V_{G2S} = 4 \dots 0\text{ V}$, $f = 800\text{ MHz}$	ΔG_p	45	-	-	
Cross-modulation $k=1\%$, $f_w=50\text{MHz}$, $f_{unw}=60\text{MHz}$ amp.A , AGC = 0 dB amp. B, AGC = 0 dB amp. A , AGC = 10 dB amp. B , AGC = 10 dB amp. A, AGC = 40 dB amp. B, AGC = 40 dB	X_{mod}	90 90 - - 98 98	96 97 91 94 103 104	- - - - - -	-

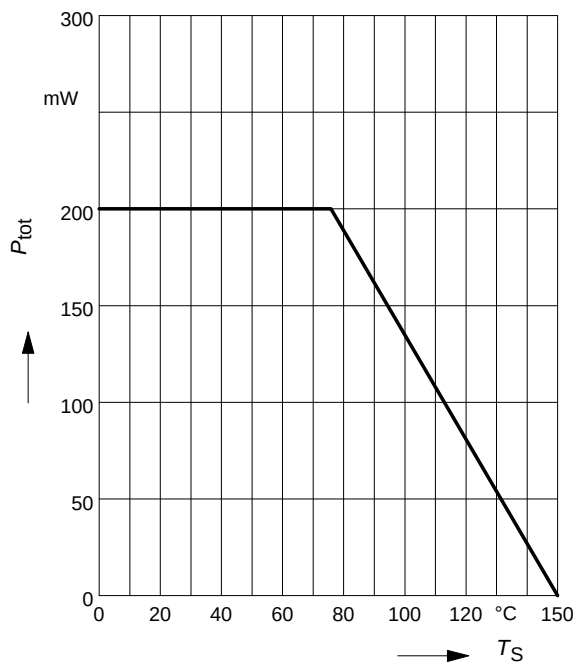
Total power dissipation $P_{\text{tot}} = f(T_S)$

amp. A



Total power dissipation $P_{\text{tot}} = f(T_S)$

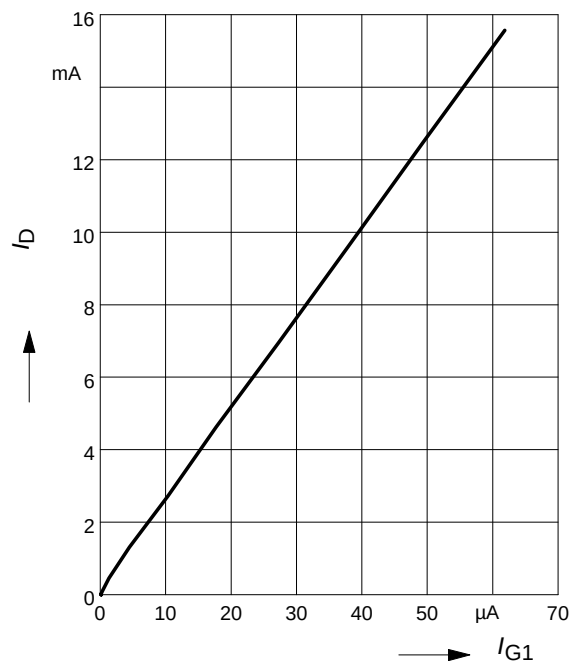
amp. B



Drain current $I_D = f(I_{G1})$

$V_{G2S} = 4V$

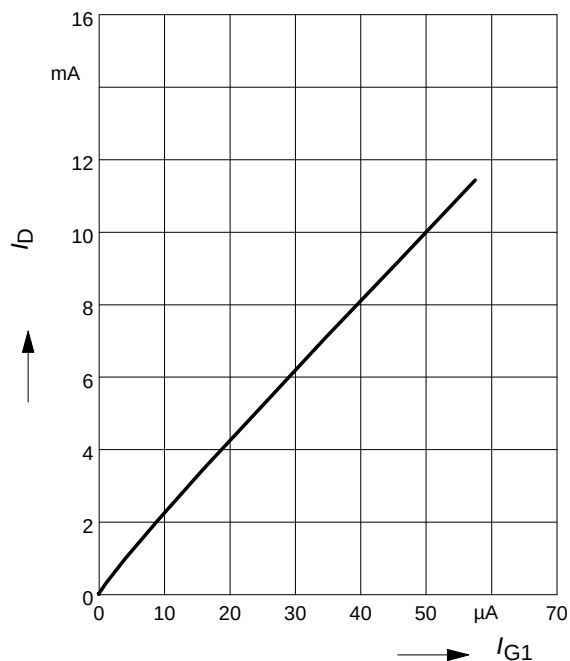
amp. A



Drain current $I_D = f(I_{G1})$

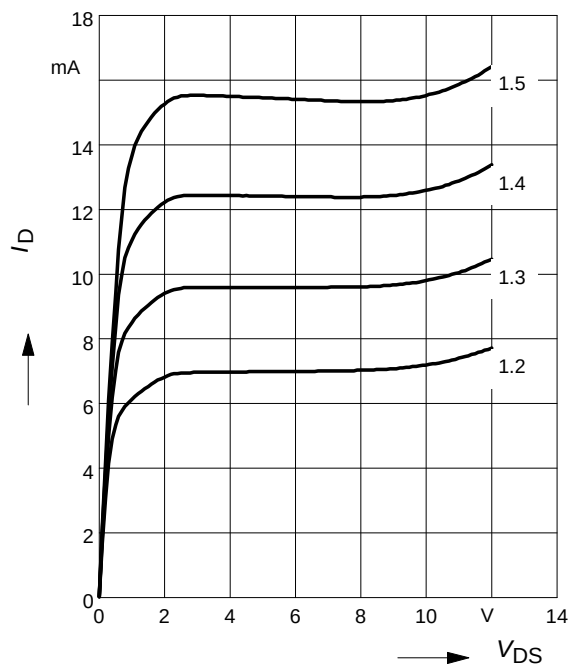
$V_{G2S} = 4V$

amp. B

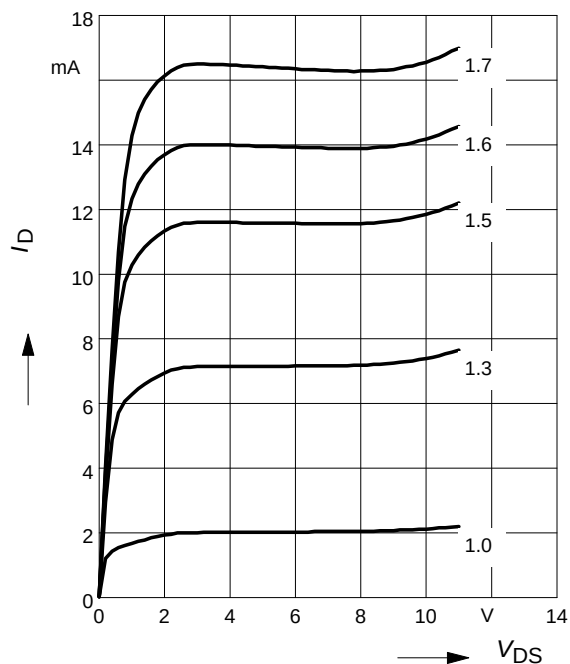


Output characteristics $I_D = f(V_{DS})$

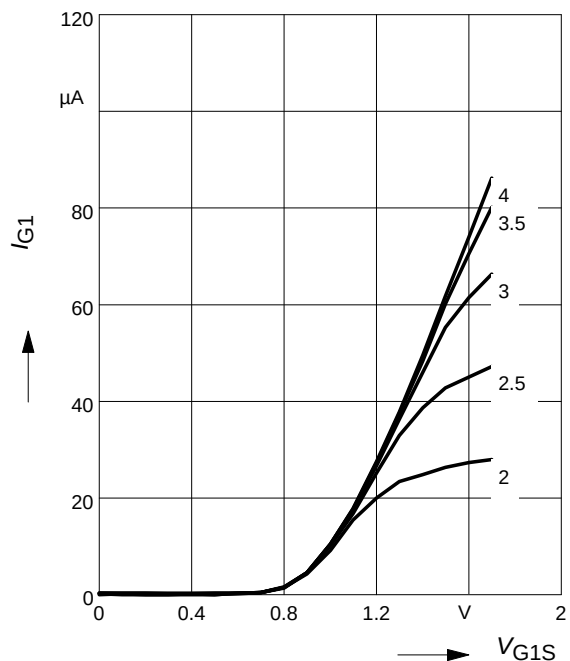
$V_{G2S} = 4V$, $V_{G1S} = \text{Parameter in V}$
amp. A


Output characteristics $I_D = f(V_{DS})$

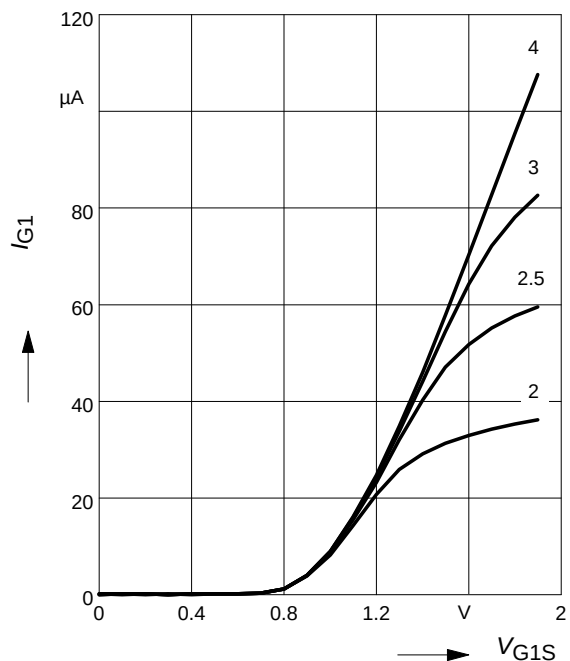
$V_{G2S} = 4V$, $V_{G1S} = \text{Parameter in V}$
amp. B


Gate 1 current $I_{G1} = f(V_{G1S})$

$V_{DS} = 5V$, $V_{G2S} = \text{Parameter in V}$
amp. A

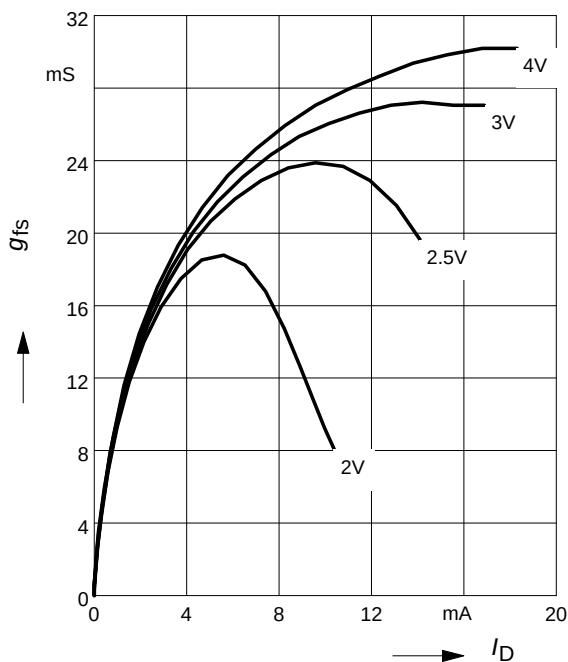

Gate 1 current $I_{G1} = f(V_{G1S})$

$V_{DS} = 5V$, $V_{G2S} = \text{Parameter in V}$
amp. B

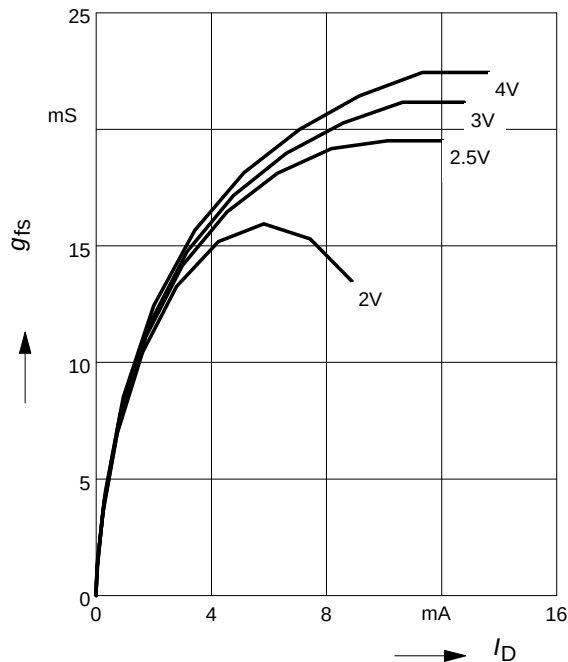


Gate 1 forward transconductance

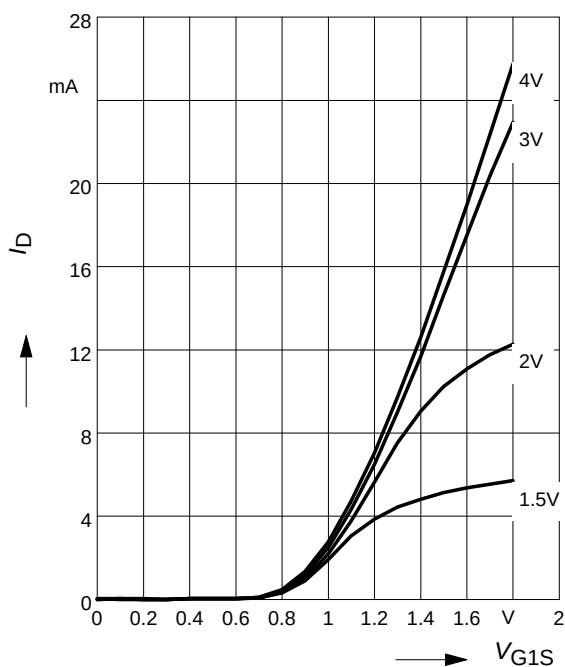
$g_{fs} = f(I_D)$, $V_{DS} = 5V$, $V_{G2S} = \text{Parameter}$
amp. A


Gate 1 forward transconductance

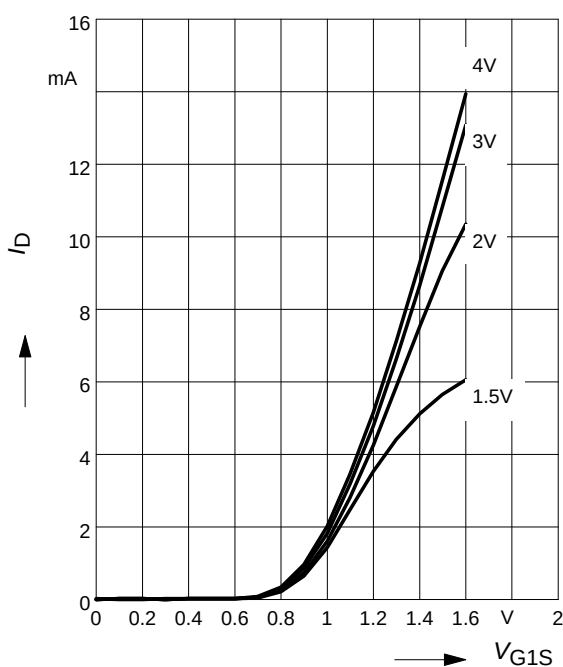
$g_{fs} = f(I_D)$, $V_{DS} = 5V$, $V_{G2S} = \text{Parameter}$
amp. B


Drain current $I_D = f(V_{G1S})$

$V_{DS} = 5V$, $V_{G2S} = \text{Parameter}$
amp. A


Drain current $I_D = f(V_{G1S})$

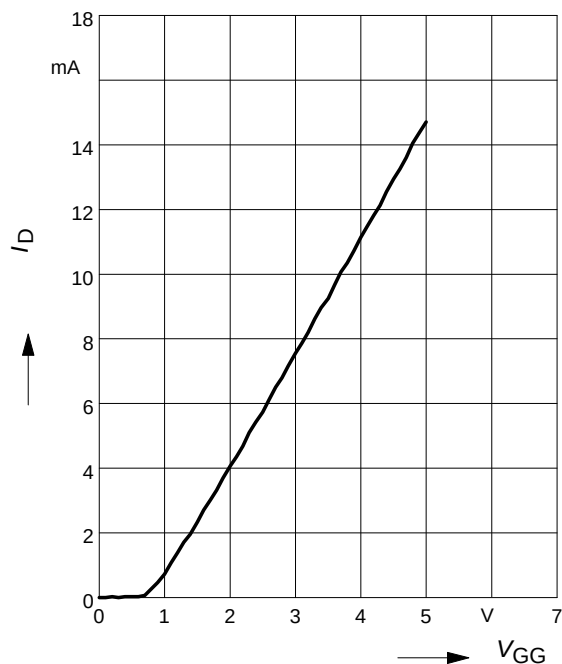
$V_{DS} = 5V$, $V_{G2S} = \text{Parameter}$
amp. B



Drain current $I_D = f(V_{GG})$ amp. A

$V_{DS} = 5V$, $V_{G2S} = 4V$, $R_{G1} = 60k\Omega$

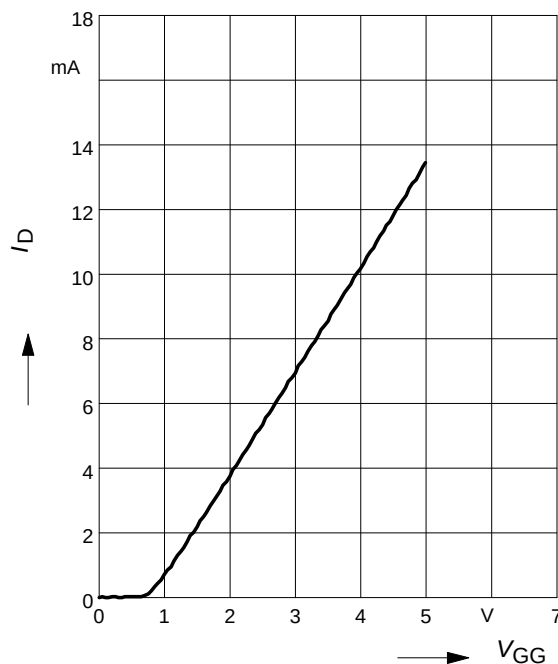
(connected to V_{GG} , $V_{GG} = \text{gate1 supply voltage}$)



Drain current $I_D = f(V_{GG})$ amp. B

$V_{DS} = 5V$, $V_{G2S} = 4V$, $R_{G1} = 50k\Omega$

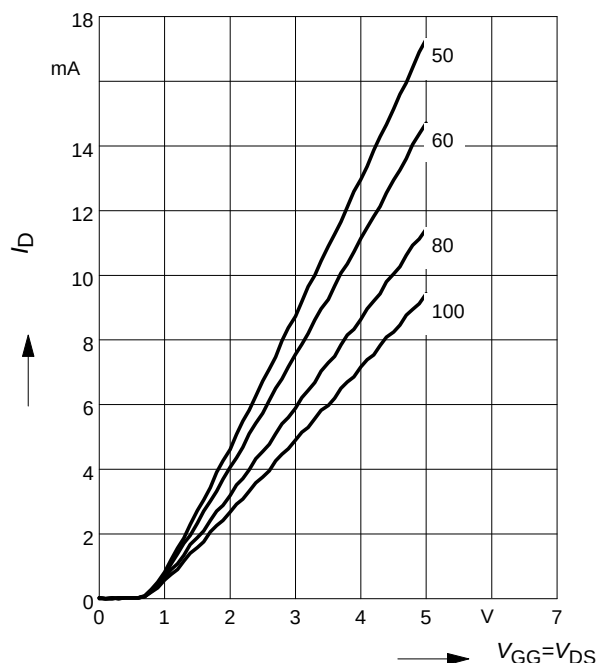
(connected to V_{GG} , $V_{GG} = \text{gate1 supply voltage}$)



Drain current $I_D = f(V_{GG})$

$V_{G2S} = 4V$, $R_{G1} = \text{Parameter in } k\Omega$

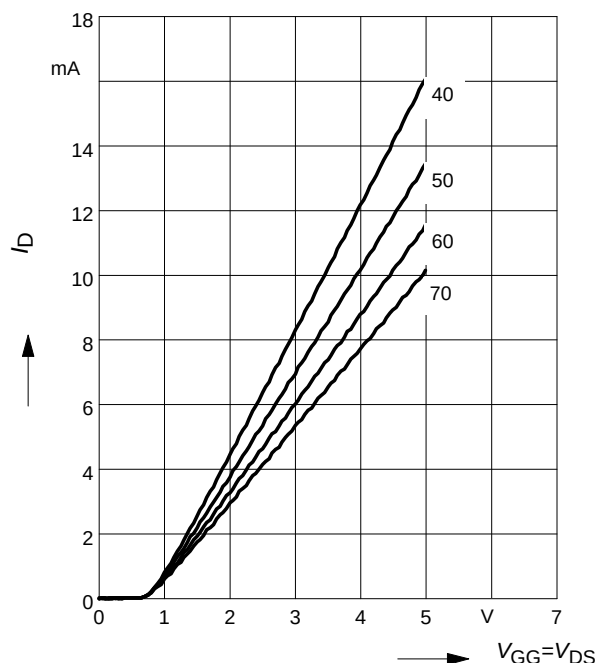
amp. A

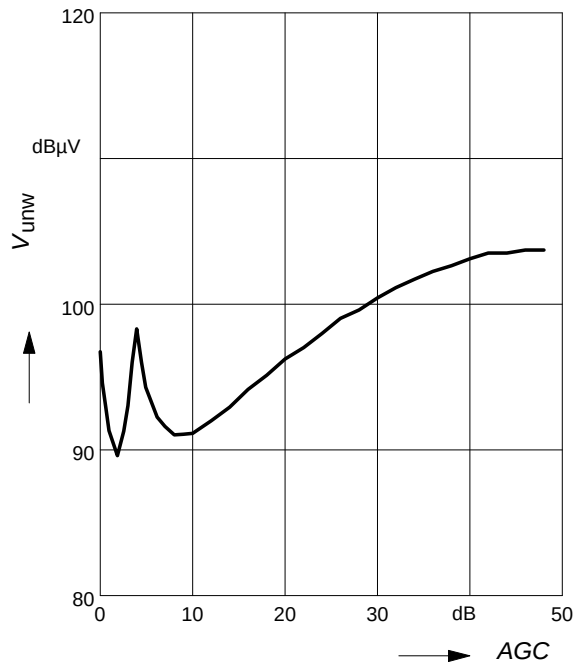
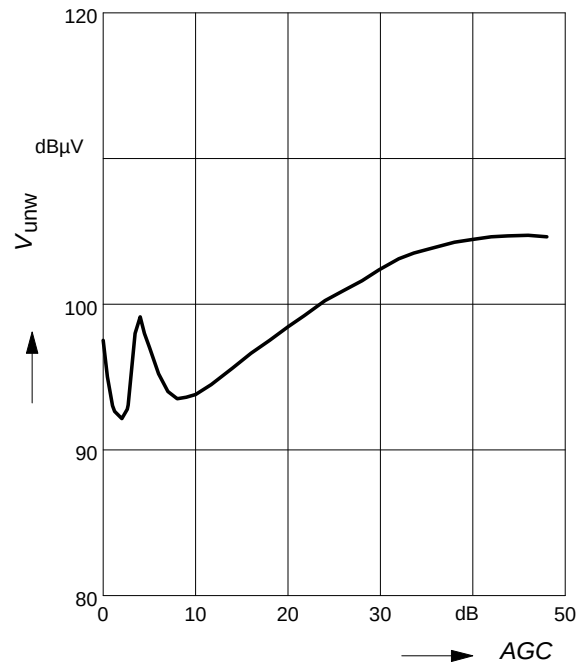


Drain current $I_D = f(V_{GG})$

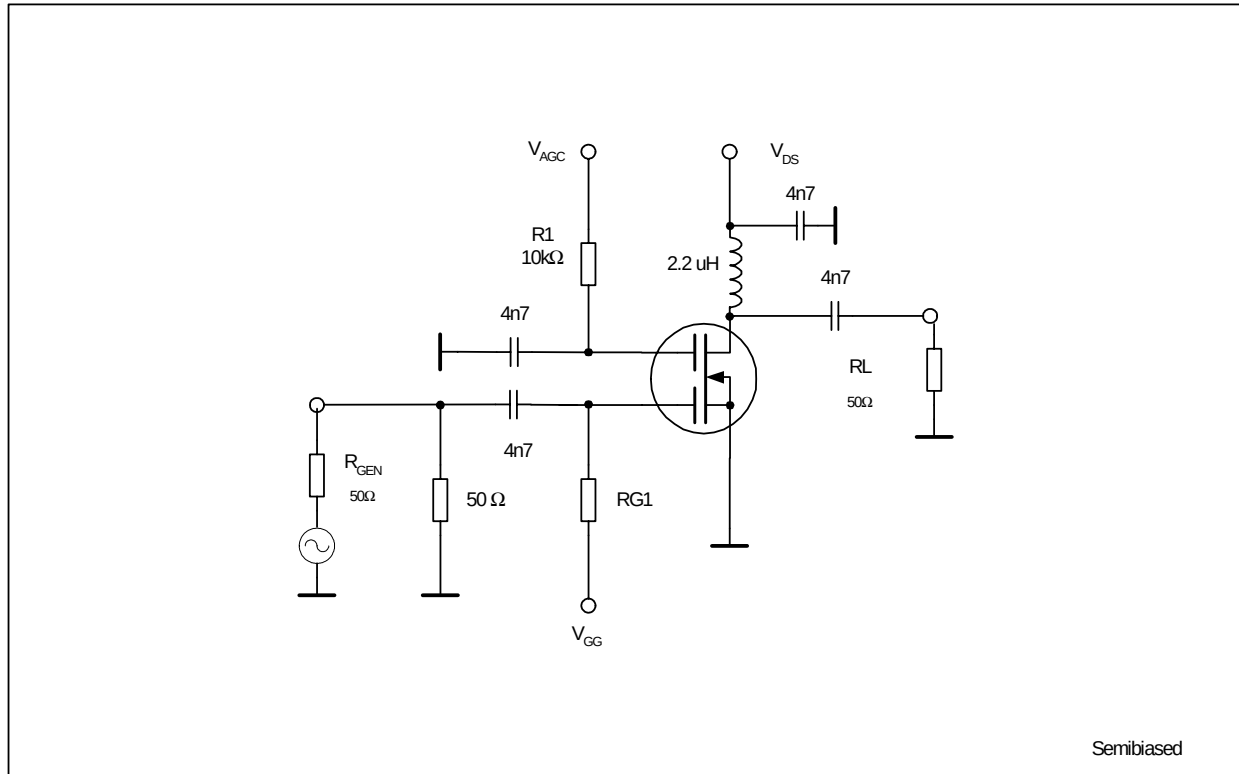
$V_{G2S} = 4V$, $R_{G1} = \text{Parameter in } k\Omega$

amp. B



Crossmodulation $V_{unw} = (AGC)$
 $V_{DS} = 5 \text{ V}, R_{g1} = 68 \text{ k}\Omega$
amp.A

Crossmodulation $V_{unw} = (AGC)$
 $V_{DS} = 5 \text{ V}, R_{g1} = 56 \text{ k}\Omega$
amp.B


Crossmodulation test circuit



The diagram shows a rectangular component with six pins. The marking on the component is as follows:

- Manufacturer:** Infineon technologies (indicated by a logo and text above the component).
- Date code (Year/Month):** 2005, June (indicated by the text '2005, June' and 'Date code (Year/Month)' pointing to the '56' marking).
- Type code:** BCR108S (indicated by the text 'BCR108S' and 'Type code' pointing to the '56' marking).
- Pin 1 marking:** A small circle (indicated by the text 'Pin 1 marking' and 'Laser marking' pointing to the circle).
- Other markings:** 'WH' and 's' are also visible on the component.

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